Supplementary materials:

## Ionic cross-linked polyvinyl alcohol tune vitrification and coldcrystallization of sugar alcohol for long-term thermal energy storage

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Figure S3. Micrographs of CC-PCM (composition A) on cooling from molten state at 120 °C to deeply supercooled state and cold-crystallization on reheating. Note the spheres in the micrographs of molten state are air bobbles appeared during sample preparation between the glass slides and cover glass.

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Differential Scanning Calorimetry (DSC) Methodology:

Differential scanning calorimetry (DSC) is the most common standard method used to determine the latent heat (enthalpy) of crystallization and melting and corresponding phase transition temperatures of phase change materials (PCMs).<sup>1</sup> DSC measures the difference of heat flow rate in a sample PCM and a reference (usually alumina) as a function of the temperature, when both the sample and the reference are exposed to the same DSC heating-cooling program.<sup>2</sup> An exothermic crystallization reaction in the sample causes a heat flow out of the sample, while, the heat flows into the sample by an endothermic melting reaction. Based on the developed temperature differences between the sample and the reference, DSC measures the heat flow as the plot of the heat flow versus temperature (DSC curve). Latent heat (enthalpy) of the phase change (crystallization and melting) is determined as the area under the exothermic and endothermic peaks on the DSC curve, respectively. The phase transition temperatures are assigned to the onset of the peaks determined by line fitting. <sup>1-3</sup> An example DSC curve and corresponding phase change measurements are illustrated in Figure S1. For instance, the latent heat of cold-crystallization and melting for the sample B2 are  $\Delta H_{cc} = -157$  J/g and  $\Delta H_m = 231$  J/g, respectively. Table 2 in the article reports the measured latent heat storage properties for the rest of the compositions.



**Figure S1**. DSC measurements of the latent heat storage properties for composition B2; solid line is the heating and dashes are cooling cycles under 5 K/min DSC scan rate.  $\Delta H_{cc}$  is the amount of latent heat released during cold-crystallization and  $\Delta H_m$  is the amount of latent heat absorbed during melting.



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## References

- 1. M. K. Rathod and J. Banerjee, *Renewable and Sustainable Energy Reviews*, 2013, **18**, 246-258.
- 2. J. D. Menczel and R. B. Prime, *Thermal Analysis of Polymers: Fundamentals and Applications*, John Wiley & Sons, 2014.
- 3. G. Höhne, W. F. Hemminger and H.-J. Flammersheim, *Differential scanning calorimetry*, Springer Science & Business Media, 2013.
- 4. C. Ceccarelli, G. A. Jeffrey and R. K. McMullan, *Acta Crystallographica*, 1980, **B36**, 3079-3083.